

Arcam EBM Q20plus v2.0

The Arcam EBM Q20plus build envelope allows for producing large components and optimal stacking of smaller ones, while its build chamber interior is developed for easy powder handling and fast turn-around.

The Q20plus is upgraded with new improved high voltage unit and amplifier. It also has a new powder layering system similar to the Spectra platform.

Technical Data

Max. build size Max. beam power Cathode type Min. beam diameter Max. EB translation speed Active cooling Minimum chamber pressure Typical build atmosphere He consumption, build process He consumption, ventilation Power supply Size approx. Weight CAD interface

Materials available

350 x 380 mm (Ø x H) 3kW Single crystalline 140 µm 8,000 m/s Water-cooled heat sink 5 x 10-4 mbar 4 x 10-3 mbar (partial pressure of He) 4 l/h 100-150 l/build 3 x 400 V, 32 A, 7 kW 2,400 x 1,300 x 2,945 mm (W x D x H) 2,900 kg Standard: STL

Arcam EBM Ti6Al4V Grade 5, P-Mtrl Arcam EBM Ti6Al4V Grade 23, P-Mtrl

- > Build envelope is designed for production of large parts
- > Arcam xQam for high-precision autocalibration
- > Arcam LayerQam for quality control of each layer



